## **PRODUCT / PROCESS CHANGE NOTIFICATION**

1. PCN basic data		
1.1 Company		STMicroelectronics International N.V
1.2 PCN No.		AMS/19/11619
1.3 Title of PCN		New Molding Compound in TO92 package to replace SAMSUNG SDI under termination phase
1.4 Product Category		See product list
1.5 Issue date		2019-07-06

2. PCN Team	
2.1 Contact supplier	
2.1.1 Name	NEMETH KRISZTINA
2.1.2 Phone	+49 89460062210
2.1.3 Email	krisztina.nemeth@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Lorenzo NASO
2.1.2 Marketing Manager	Marcello SAN BIAGIO
2.1.3 Quality Manager	Sergio Tommaso SPAMPINATO

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials	New direct material part number (same supplier, different supplier or new supplier), Mold compound	ASE WEIHAI - CHINA

4. Description of change		
	Old	New
4.1 Description	Molding compound : SAMSUNG EMC type SG-8100GS	Molding compound : EMC GR30HT (Hysol Huawei) as first choice. While considering to qualify 2nd source as back-up (to update Rel result once available).
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change	
	As anticipated by ST Corporate PCI No. CRP/19/11478, this PCN is to announce the replacement of current molding compound SAMSUNG EMC type SG-8100GS for TO 92 package assembled in ASE WEIHAI Plant
5.2 Customer Benefit	SERVICE CONTINUITY

6. Marking of parts / traceability of change		
6.1 Description	By internal codification and traceability code	

7. Timing / schedule	
7.1 Date of qualification results	2019-06-11
7.2 Intended start of delivery	2019-09-30
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation			
8.1 Description	11619 11619_Samsung MC.zip		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2019-07-06

### 11619 Public product.pdf 11619 11619\_Samsung MC.zip

10. Affected parts			
10. 1 Current		10.2 New (if applicable)	
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No	
L78L05ABZ	L78L05ABZ		
L78L09ACZ-AP	L78L09ACZ-AP		
L78L09ACZ-TR	L78L09ACZ-TR		
L78L12ACZ	L78L12ACZ		
L78L15ACZ	L78L15ACZ		
L79L05ACZ	L79L05ACZ		
LE33CZ-TR	LE33CZ-TR		
LE50ABZ-AP	LE50ABZ-AP		
LM317LZ-TR	LM317LZ-TR		
TL1431ACZ	TL1431ACZ		
TL431ACZ	TL431ACZ		
TL431ACZT	TL431ACZT		
TL431AIZ	TL431AIZ		
TL431CZ	TL431CZ		

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# **Public Products List**

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*PCN Title :* New Molding Compound in TO92 package to replace SAMSUNG SDI under termination phase *PCN Reference :* AMS/19/11619

Subject : Public Products List

Dear Customer,

## Please find below the Standard Public Products List impacted by the change.

LM317LZ	TL431AIZ-AP
TS431IZ-AP	L78L33ACZ
L79L08ACZ-AP	TL1431ACZ
L78L24ACZ-AP	L78L05ABZ
L78L12ABZ	L78L12ABZ-AP
L78L33ABZ-AP	TL431ACZ-AP
TL1431AIZT	TL431AIZT
TL431CZ-AP	TL1431IZT
L78L05CZ	TL1431CZ-AP
TL431ACZT	TL431IZ-AP
TL431CZ	L78L09ABZ
L78L08ABZ-AP	L78L33ACZ-AP
L78L05ABZ-AP	TS431AIZ
TS431IZ	LE33CZ-AP
L4931CZ50-AP	TL1431ACZ-AP
L78L05ACZ-AP	L78L08ACZ
TS431AIZT	L78L08ABZTR
TL431AIZ	TL431CZT
L78L09ACZ-TR	TS831-5IZ-AP
L78L08ACZTR	L78L12ACZ-AP
L79L12ACZ-TR	TL1431AIZ-AP
L78L15ACZ	L78L05ACZ
L78L12ACZ-TR	LE50ABZ-AP
L78L06ABZ	LM317LZ-AP
	TS431IZ-AP   L79L08ACZ-AP   L78L24ACZ-AP   L78L12ABZ   L78L33ABZ-AP   TL1431AIZT   TL431CZ-AP   L78L05CZ   TL431ACZT   TL431CZ   L78L05ABZ-AP   L78L05ABZ-AP   TS431IZ   L78L05ABZ-AP   TS431IZ   L78L05ABZ-AP   TS431IZ   L4931CZ50-AP   L78L05ACZ-AP   TS431AIZT   TL431AIZ   L78L09ACZ-TR   L78L08ACZTR   L78L08ACZ-TR   L78L12ACZ-TR   L78L12ACZ-TR

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